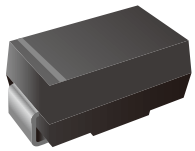
LT3A200

Surface Mount Schottky Barrier Rectifier

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case:SMA
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Approx. Weight: 60mg

Ordering Information

Part Number	Marking	Shipping	Reel
LT3A200-TR5	3A200	5000PCS Tape&Reel	13 inchs
LT3A200-TR7K5	3A200	7500PCS Tape&Reel	13 inchs

Maximum Ratings and Electrical Characteristics

Ratings at 25℃ ambient temperature unless otherwise specified.
Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	Symbol	LT3A200	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum RMS voltage	V_{RMS}	140	V
Maximum DC blocking voltage	V_{DC}	200	V
Maximum average forward rectified current @ Fig.1	$I_{F(AV)}$	3	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	100	A
Maximum instantaneous forward voltage at 3.0A	V_F	0.8	V
Maximum DC reverse current T_A=25℃ at rated DC reverse voltage T_A=100℃	I_R	0.3 3	mA
Typical junction capacitance (Note1)	C_J	80	pF
Typical thermal resistance (Note2)	$R_{\theta JA}$ $R_{\theta JC}$ $R_{\theta JL}$	100 20 25	°C/W
Operating junction temperature range	T_J	-55 to +150	°C
Storage temperature range	T_{STG}	-55 to +150	°C

Note: (1) Measured at 1MHz and applied reverse voltage of 4.0V D.C.
(2) PCB mounted with 0.2"x0.2"(5.0mm x 5.0mm) copper pad areas.

Characteristics Curves

Fig.1 Forward Current Derating Curve

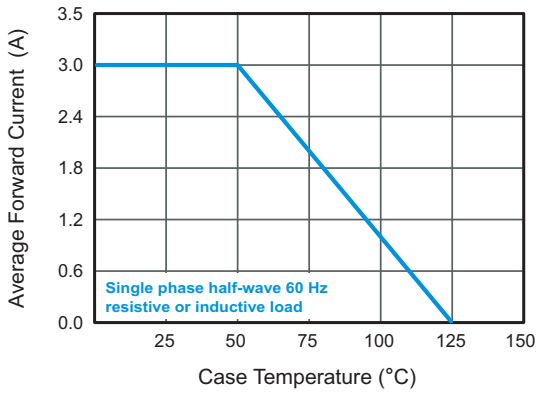


Fig.2 Typical Reverse Characteristics

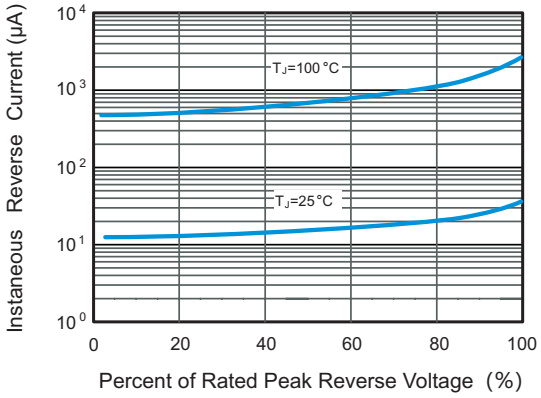


Fig.3 Typical Forward Characteristic

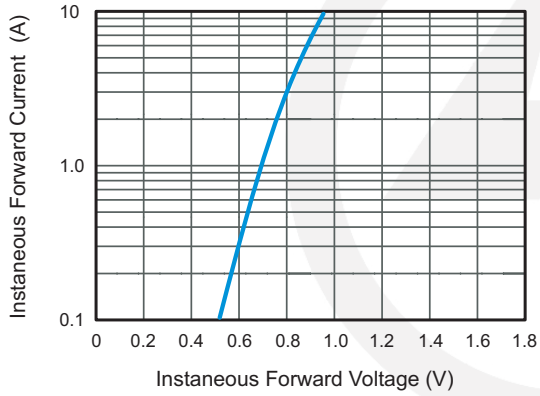


Fig.4 Typical Junction Capacitance

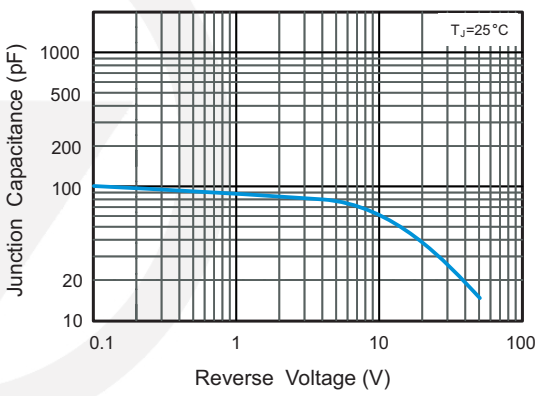
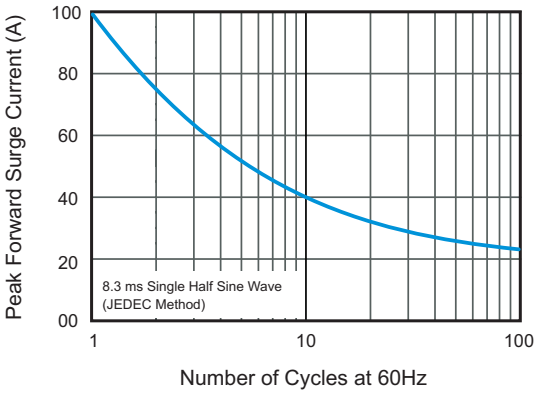
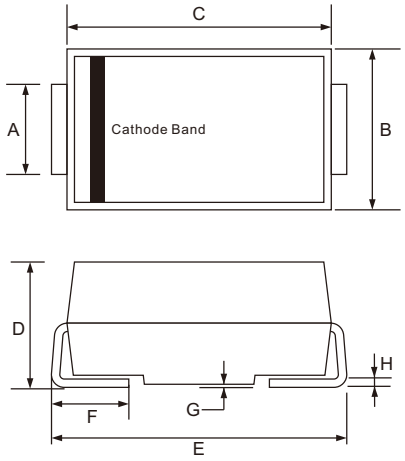


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



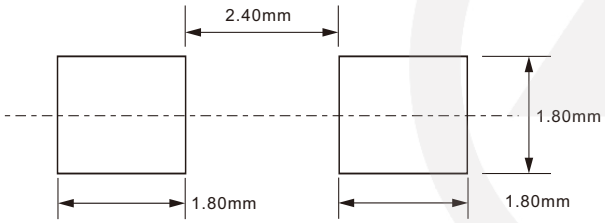
SMA Package Outline



Unit : mm

SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.25	1.65
B	2.30	2.79
C	4.00	4.75
D	1.90	2.50
E	4.70	5.28
F	0.76	1.52
G	0.203 TYP.	
H	0.15	0.31

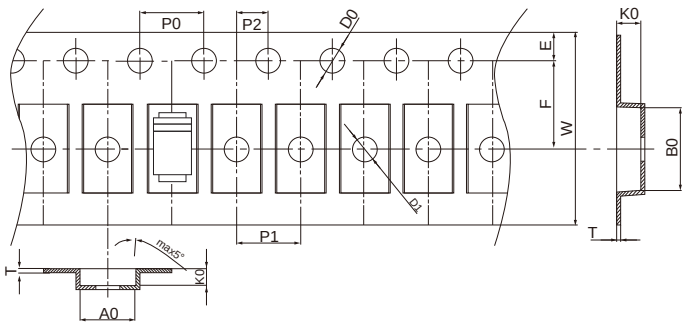
SMA Suggested Pad Layout



Note:
1.Controlling dimension:in millimeters.
2.General tolerance:± 0.05mm
3.The pad layout is for reference purpose only.

Carrier Tape Dimensions

Unit：mm

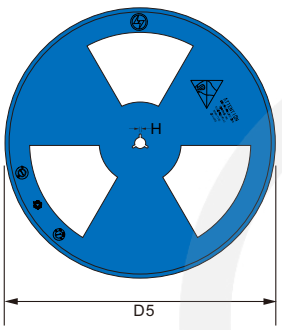


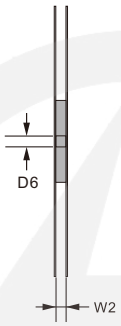
Symbol	Spec	Symbol	Spec
A0	2.70±0.10	D0	1.55±0.05
B0	5.33±0.10	D1	1.55±0.05
K0	2.35±0.10	T	0.20±0.03
P0	4.00±0.10	E	1.75±0.10
P1	4.00±0.10	F	5.50±0.05
P2	2.00±0.10	W	12.0±0.30

Reel Dimensions

Unit：mm

13” Reel



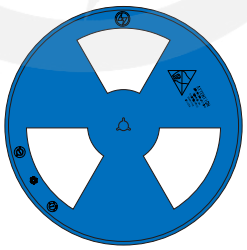


D5	Φ330.0±2.0
D6	Φ13.5±0.5
H	2.5±1.0
W2	12±2.0
Quantity: 5000/7500PCS	

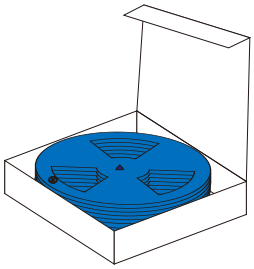
Packaging

SMA

5000PCS/Reel
7500PCS/Reel



5Reel/Inner Box
25KPCS/Inner Box
37.5KPCS/Inner Box



Dim(Unit:mm)
340mm*340mm*85mm

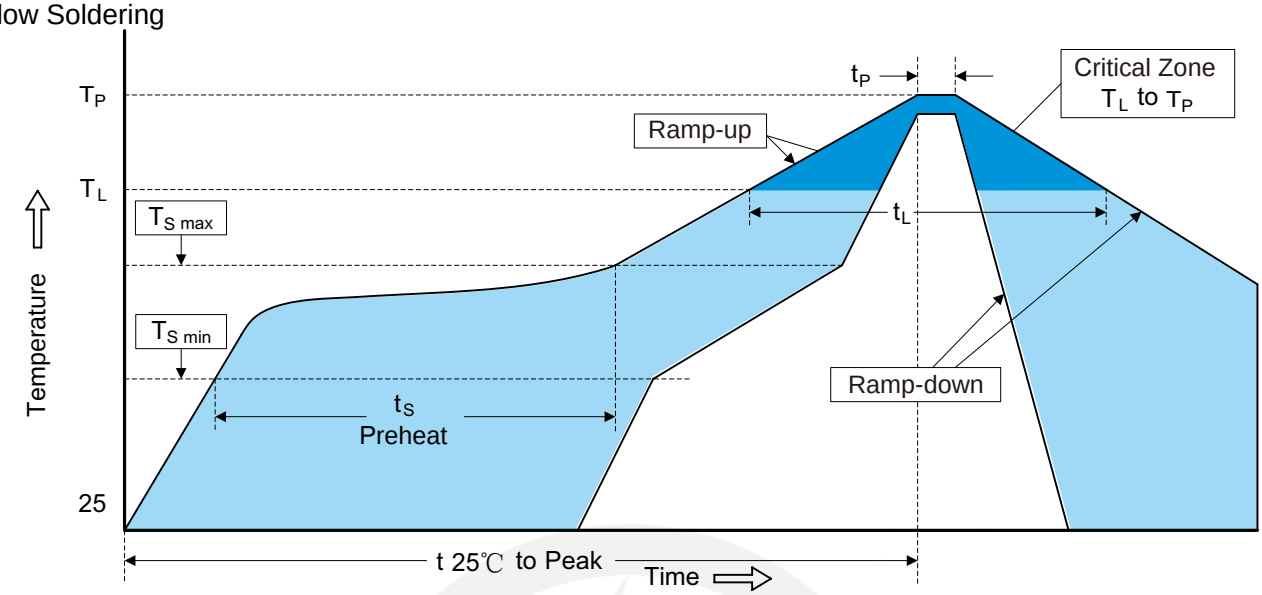
4 Boxs per carton
100KPCS per carton
150KPCS per carton

Dim(Unit:mm)
360mm*360mm*355mm

13 inchs Reel

Recommended Soldering Conditions

Reflow Soldering



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3℃/second max.
Preheat -Temperature Min ($T_{S\ min}$) -Temperature Max ($T_{S\ max}$) -Time (min to max) (t_S)	 150℃ 200℃ 60-180 seconds
$T_{S\ max}$ to T_L -Ramp-up Rate	 3℃/second max.
Time maintained above: -Temperature (T_L) -Time (t_L)	 217℃ 60-150 seconds
Peak Temperature (T_P)	260℃
Time within 5℃ of actual Peak Temperature (t_P)	20-40 seconds
Ramp-down Rate	6℃/second max.
Time 25℃ to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision Content	Revision Reason	Revision Person	Note
01	2025.05.17	2025.05.17	3.0	New file	/	Ding	